

## FEATURES/BENEFITS

- Enhanced N channel FET with no inherent diode to  $V_{CC}$
- $5\Omega$  bidirectional switches connect inputs to outputs
- Pin compatible with the 74F257, 74FCT257, and 74FCT257T
- Zero propagation delay, zero ground bounce
- TTL-compatible control inputs
- Undershoot clamp diodes on all switch and control pins
- Available in SOIC (S1), QSOP
- QS32257 is  $25\Omega$  version for low noise

## APPLICATIONS

- Logic replacement
- Video, audio, graphics switching, muxing
- Hot-swapping, hot-docking  
(Application Note AN-13)
- Voltage translation  
(5V to 3.3V; Application Note 11)
- Bus funneling

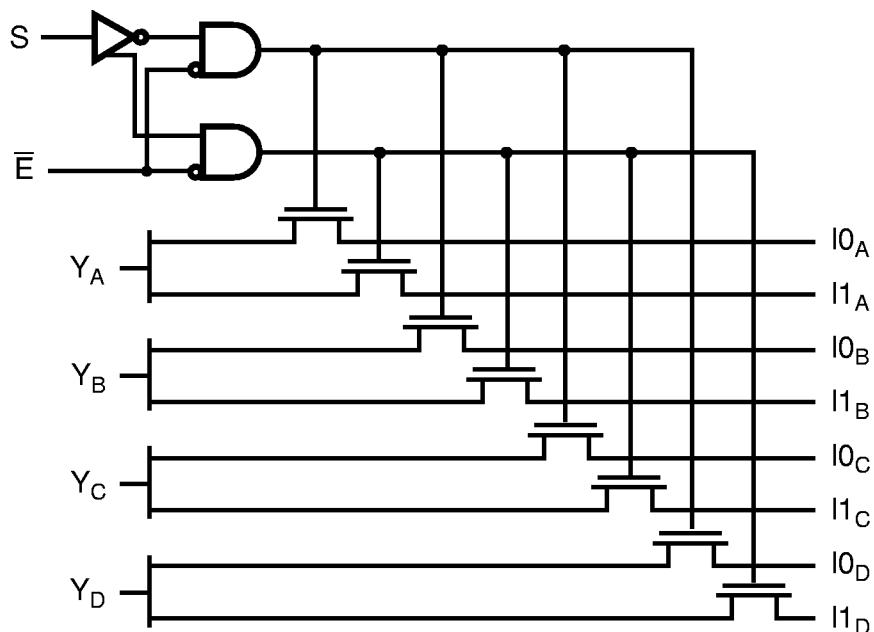
## DESCRIPTION

The QS3257 is a high-speed CMOS LVTTL-compatible Quad 2:1 multiplexer/demultiplexer. The QS3257 is a function and pinout compatible QuickSwitch version of the 74F257, 74FCT257, and the 74ALS/AS/LS257 Quad 2:1 multiplexers. The low ON resistance of the QS3257 allows inputs to be connected to outputs without adding propagation delay and without generating additional ground bounce noise. The QS32257 has  $25\Omega$  series resistors to reduce ground bounce noise.

Mux/Demux devices provide an order of magnitude faster speed than equivalent logic devices.

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**Figure 1. Functional Block Diagram**

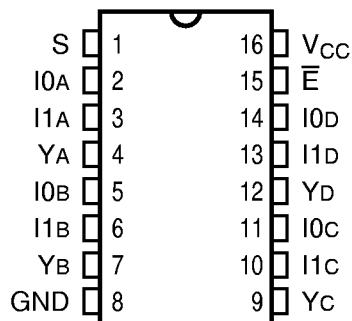


**Table 1. Pin Description**

Name	I/O	Description
I <sub>xx</sub>	I	Data Inputs
S	I	Select Input
Ē	I	Enable Input
Y <sub>A</sub> -Y <sub>D</sub>	O	Data Outputs

**Figure 2. Pin Configuration  
(All Pins Top View)**

SOIC (S1), QSOP

**Table 2. Function Table**

Inputs		Outputs				Function
Ē	S	Y <sub>A</sub>	Y <sub>B</sub>	Y <sub>C</sub>	Y <sub>D</sub>	
H	X	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Disable
L	L	I0A	I0B	I0C	I0D	Select 0
L	H	I1A	I1B	I1C	I1D	Select 1

**Table 3. Absolute Maximum Ratings**

Supply Voltage to Ground .....	-0.5V to +7.0V
DC Switch Voltage V <sub>S</sub> .....	-0.5V to +7.0V
DC Input Voltage V <sub>IN</sub> .....	-0.5V to +7.0V
AC Input Voltage (for a pulse width ≤ 20ns) .....	-3.0V
DC Output Current Max. Sink Current/Pin .....	120mA
Maximum Power Dissipation.....	0.5 watts
T <sub>STG</sub> Storage Temperature .....	-65° to +150°C

**Note:** ABSOLUTE MAXIMUM CONTINUOUS RATINGS are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute-maximum conditions is not implied.

**Table 4. Capacitance**T<sub>A</sub> = 25°C, f = 1MHz, V<sub>IN</sub> = 0V, V<sub>OUT</sub> = 0V

Pins		SOIC, QSOP Typ	Max	Unit
Control Inputs		4	5	pF
QuickSwitch Channels (Switch OFF)	Demux	5	7	pF
	Mux	8	9	pF

**Note:** Capacitance is guaranteed, but not production tested and are typical values. For total capacitance while the switch is ON, please see Section 1 under "Input and Switch Capacitance."

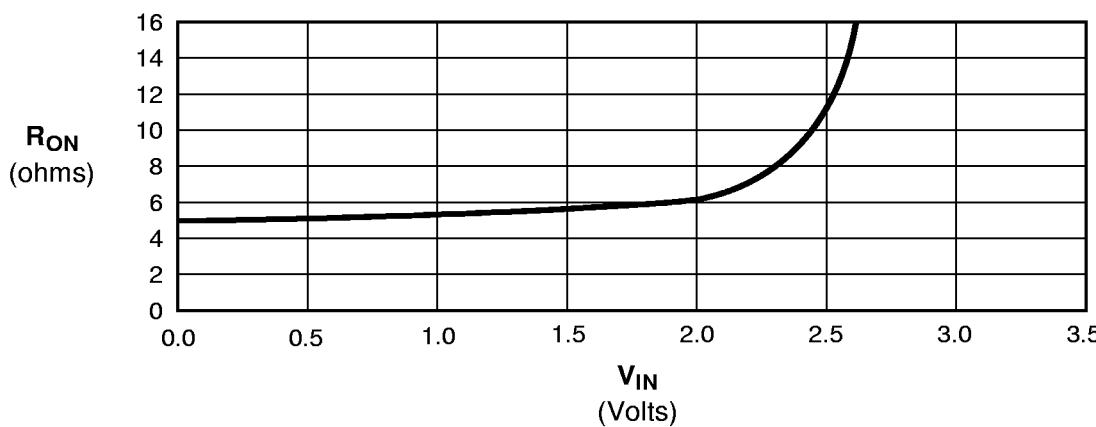
**Table 5. DC Electrical Characteristics Over Operating Range**Commercial  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ ,  $V_{CC} = 5.0\text{V} \pm 5\%$ , Military:  $T_A = -55^\circ\text{C}$  to  $125^\circ\text{C}$ ,  $V_{CC} = 5.0\text{V} \pm 10\%$ 

Symbol	Parameter	Test Conditions	Min	Typ <sup>(1)</sup>	Max	Unit
$V_{IH}$	Input HIGH Voltage	Guaranteed Logic HIGH for Control Pins	2.0	—	—	V
$V_{IL}$	Input LOW Voltage	Guaranteed Logic LOW for Control Pins	—	—	0.8	V
$ I_{IN} $	Input Leakage Current (Control Inputs)	$0\text{V} \leq V_{IN} \leq V_{CC}$	—	—	1	$\mu\text{A}$
$ I_{OZ} $	Off-State Current (Hi-Z)	$0\text{V} \leq V_{OUT} \leq V_{CC}$	—	—	1	$\mu\text{A}$
$R_{ON}$	Switch On Resistance <sup>(2)</sup>	$V_{CC} = \text{Min.}, V_{IN} = 0.0\text{V}$ $I_{ON} = 30\text{mA}$	QS3257	—	5	$\Omega$
			QS32257	20	28	40
$R_{ON}$	Switch On Resistance <sup>(2)</sup>	$V_{CC} = \text{Min.}, V_{IN} = 2.4\text{V}$ $I_{ON} = 15\text{mA}$	QS3257	—	10	15
			QS32257	20	35	48
$V_P$	Pass Voltage <sup>(3)</sup>	$V_{IN} = V_{CC} = 5\text{V}, I_{OUT} = -5\mu\text{A}$	3.7	4	4.2	V

**Notes:**

1. Typical values indicate  $V_{CC} = 5.0\text{V}$  and  $T_A = 25^\circ\text{C}$ .
2. For a diagram explaining the procedure for  $R_{ON}$  measurement, please see Section 1 under "DC Electrical Characteristics."  $R_{ON}$  guaranteed, but not production tested.
3. Pass voltage is guaranteed, but not production tested.

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**Figure 3. Typical ON Resistance vs.  $V_{IN}$  at  $V_{CC} = 5.0\text{V}$  (QS3257)****Note:** For QS32257, add  $23\Omega$  to  $R_{ON}$  shown.

**Table 6. Power Supply Characteristics Over Operating Range** $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ ,  $V_{CC} = 5.0\text{V} \pm 5\%$ 

Symbol	Parameter	Test Conditions <sup>(1)</sup>	Max	Unit
$I_{CCQ}$	Quiescent Power Supply Current	$V_{CC} = \text{Max.}$ , $V_{IN} = \text{GND or } V_{CC}$ , $f = 0$	3.0	$\mu\text{A}$
$\Delta I_{CC}$	Power Supply Current <sup>(2)</sup> per Input HIGH	$V_{CC} = \text{Max.}$ , $V_{IN} = 3.4\text{V}$ , $f = 0$ per control input	1.5	mA
$Q_{CCD}$	Dynamic Power Supply Current per MHz <sup>(3)</sup>	$V_{CC} = \text{Max.}$ , I and Y Pins Open, Control Inputs Toggling @ 50% Duty Cycle	0.25	mA/ MHz

**Notes:**

- For conditions shown as Min. or Max., use the appropriate values specified under DC specifications.
- Per TTL driven-input ( $V_{IN} = 3.4\text{V}$ , control inputs only). I and Y pins do not contribute to  $\Delta I_{CC}$ .
- This parameter applies to the control inputs only and represents the current required to switch internal capacitance at the specified frequency. The I and Y inputs generate no significant AC or DC currents as they transition. This parameter is guaranteed, but not production tested.

**Table 7. Switching Characteristics Over Operating Range** $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ ,  $V_{CC} = 5.0\text{V} \pm 5\%$  $C_{LOAD} = 50\text{pF}$ ,  $R_{LOAD} = 500\Omega$  unless otherwise noted.

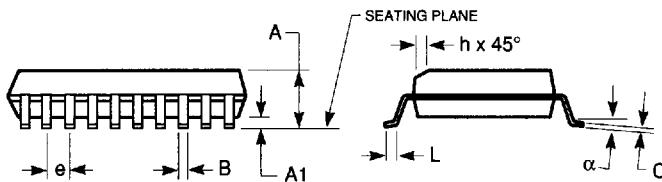
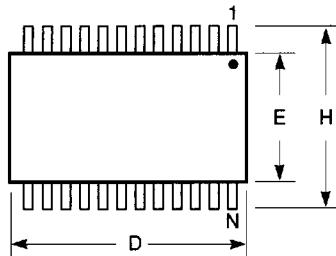
Symbol	Description <sup>(1)</sup>	QS257			QS2257			Unit
		Min	Typ	Max	Min	Typ	Max	
$t_{PLH}$	Data Propagation Delays <sup>(2,3)</sup> In to Y	—	—	0.25 <sup>(3)</sup>	—	—	1.25 <sup>(3)</sup>	ns
$t_{PHL}$								
$t_{PZH}$	Switch Turn-on Delay Sn to Y	0.5	—	5.2	0.5	—	6.2	ns
$t_{PZL}$								
$t_{PZH}$	Switch Turn-on Delay $\bar{En}$ to Y	0.5	—	4.8	0.5	—	5.8	ns
$t_{PZL}$								
$t_{PHZ}$	Switch Turn-off Delay <sup>(2)</sup> $\bar{En}$ to Y, Sn to Y	0.5	—	5.0	0.5	—	5.0	ns
$t_{PLZ}$								

**Notes:**

- See Test Circuit and Waveforms. Minimums guaranteed, but not production tested.
- This parameter is guaranteed, but not production tested.
- The bus switch contributes no propagation delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25ns for QS3257 and 1.25ns for QS32257 for  $C_L = 50\text{pF}$ . Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

## 300-MIL SOIC - Package Code SO

Plastic Small Outline Gull-Wing



**Notes:**

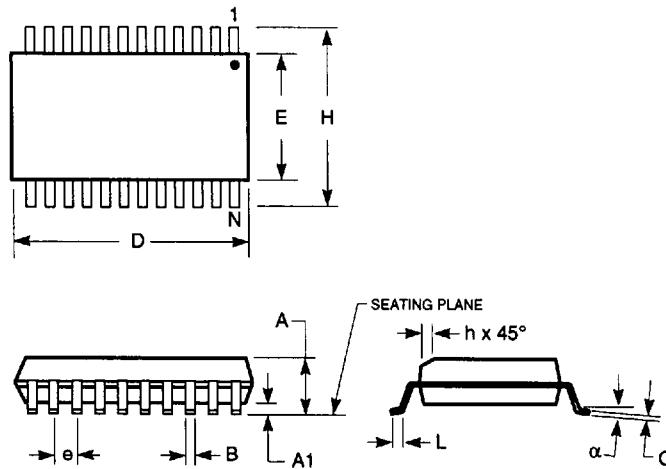
1. Refer to applicable symbol list.
2. All dimensions are in inches.
3. N is the number of lead positions.
4. Dimensions D and E are to be measured at maximum material condition but do not include mold flash. Allowable mold flash is 0.006in. per side.
5. Lead coplanarity is 0.004in. maximum.

JEDEC#	MS-013AA		MS-013AC		MS-013AD		MS-013AE	
DWG#	PS16A		PS20A		PS24A		PS28A	
Symbol	Min	Max	Min	Max	Min	Max	Min	Max
A	0.096	0.104	0.096	0.104	0.096	0.104	0.096	0.104
A1	0.005	0.011	0.005	0.011	0.005	0.011	0.005	0.011
B	0.014	0.019	0.014	0.019	0.014	0.019	0.014	0.019
C	0.009	0.012	0.009	0.012	0.009	0.012	0.009	0.012
D	0.402	0.412	0.500	0.510	0.602	0.612	0.701	0.711
E	0.292	0.299	0.292	0.299	0.292	0.299	0.292	0.299
e	0.044	0.056	0.044	0.056	0.044	0.056	0.044	0.056
H	0.396	0.416	0.396	0.416	0.396	0.416	0.396	0.416
h	0.010	0.016	0.010	0.016	0.010	0.016	0.010	0.016
L	0.020	0.040	0.020	0.040	0.020	0.040	0.020	0.040
N	16		20		24		28	
α	0°	8°	0°	8°	0°	8°	0°	8°

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## 150-MIL SOIC - Package Code S1

Plastic Small Outline Gull-Wing



JEDEC#	MS-012AB			MS-012AC		
DWG#	PS-14B			PS-16B		
Symbol	Min	Nom	Max	Min	Nom	Max
A	0.060	0.064	0.068	0.060	0.064	0.068
A1	0.004	0.006	0.008	0.004	0.006	0.008
B	0.014	0.016	0.019	0.014	0.016	0.019
C	0.0075	0.008	0.0098	0.0075	0.008	0.0098
D	0.337	0.341	0.346	0.386	0.390	0.394
E	0.150	0.154	0.157	0.150	0.154	0.157
e	0.050 BSC			0.050 BSC		
H	0.230	0.236	0.244	0.230	0.236	0.244
h	0.010	0.013	0.016	0.010	0.013	0.016
L	0.016	0.025	0.035	0.016	0.025	0.035
N	14			16		
$\alpha$	$0^\circ$	$5^\circ$	$8^\circ$	$0^\circ$	$5^\circ$	$8^\circ$

**Notes:**

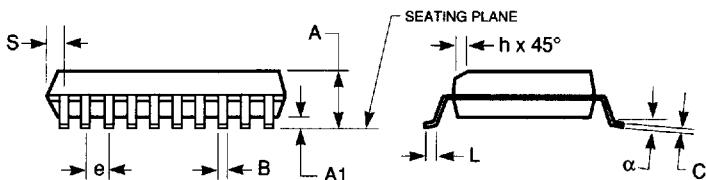
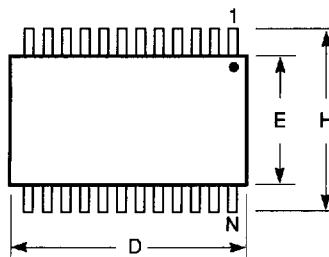
- Refer to applicable symbol list.
- All dimensions are in inches.
- N is the number of lead positions.
- Dimensions D and E are to be measured at maximum material condition but do not include mold flash. Allowable mold flash is 0.006 in. per side.
- Lead coplanarity is 0.004 in. maximum.

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## 150-MIL QSOP - Package Code Q

Quarter-Size Outline Package

Plastic Small Outline Gull-Wing



JEDEC#	MO-137AB			MO-137AD			MO-137AE			MO-137AF		
DWG#	PSS-16A			PSS-20A			PSS-24A			PSS-28A		
Symbol	Min	Nom	Max									
A	0.060	0.064	0.068	0.060	0.064	0.068	0.060	0.064	0.068	0.060	0.064	0.068
A1	0.004	0.006	0.008	0.004	0.006	0.008	0.004	0.006	0.008	0.004	0.006	0.008
B	0.009	0.010	0.012	0.009	0.010	0.012	0.009	0.010	0.012	0.009	0.010	0.012
C	0.007	0.008	0.010	0.007	0.008	0.010	0.007	0.008	0.010	0.007	0.008	0.010
D	0.189	0.193	0.197	0.337	0.341	0.344	0.337	0.341	0.344	0.386	0.390	0.394
E	0.150	0.154	0.157	0.150	0.154	0.157	0.150	0.154	0.157	0.150	0.154	0.157
e	0.025 BSC											
H	0.230	0.236	0.244	0.230	0.236	0.244	0.230	0.236	0.244	0.230	0.236	0.244
h	0.010	0.013	0.016	0.010	0.013	0.016	0.010	0.013	0.016	0.010	0.013	0.016
L	0.016	0.025	0.035	0.016	0.025	0.035	0.016	0.025	0.035	0.016	0.025	0.035
N	16			20			24			28		
α	0°	5°	8°	0°	5°	8°	0°	5°	8°	0°	5°	8°
S	0.006	0.009	0.010	0.056	0.058	0.060	0.031	0.033	0.035	0.031	0.033	0.035

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